

# N-Channel MOSFET

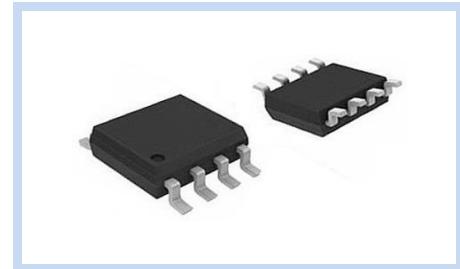
## 150V 4.0A SOP-8

MFT15N4A0S8

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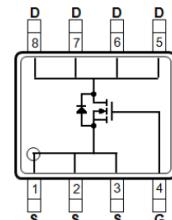
### FEATURE

- Operating temperature: -55 ~ +150 °C
- $R_{DS(ON)} < 65\text{m}\Omega$ ,  $V_{GS} = 10\text{V}$ ,  $I_D = 4.0\text{A}$
- $R_{DS(ON)} < 85\text{m}\Omega$ ,  $V_{GS} = 6\text{V}$ ,  $I_D = 2.0\text{A}$
- High switching speed
- Improved dv/dt capability
- Low reverse transfer capacitance



### MECHANICAL DATA

- Case: SOP-8 package
- Terminal: Solderable per MIL-STD-750, Method 2026

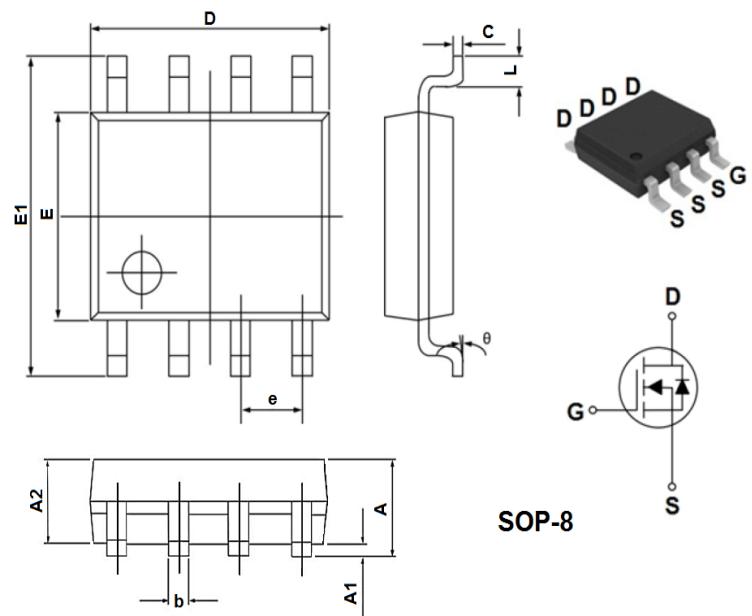


### MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	150	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	V
Drain Current – Continuous	$I_D$	4.0	A
		3.2	A
Drain Current – Pulsed	$I_{DM}$	16	A
Power Dissipation	$P_D$	2.5	W
		1.6	W
Thermal Resistance Junction to Ambient, $t \leq 10\text{s}$	$R_{\theta JA}$	50	°C/W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

### DIMENSIONS AND PIN LAYOUT

Item	Min. (mm)	Max. (mm)
A	1.35	1.75
A1	0.10	0.25
A2	1.30	1.50
b	0.31	0.51
c	0.17	0.25
D	4.80	5.00
E	3.80	4.00
E1	5.80	6.20
e	1.27 BSC	
L	0.40	1.27
$\theta$	0°	8°

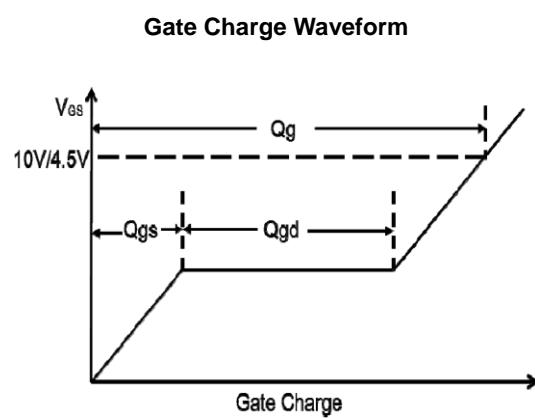
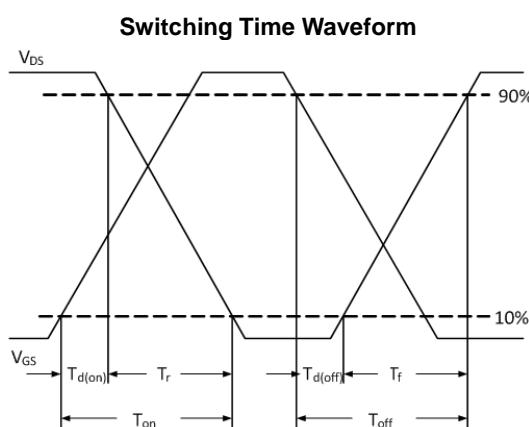


## ELECTRICAL CHARACTERISTICS

Static Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
<b>Drain-Source Breakdown Voltage</b>	$V_{GS}=0V, I_D=250\mu A$	$BV_{DS(on)}$	150	--	--	V
<b>Gate Threshold Voltage</b>	$V_{GS}=V_{DS}, I_D=250\mu A$	$V_{GS(th)}$	2.0	2.7	4.0	V
<b>Drain-Source On-Resistance</b>	$V_{GS}=10V, I_D=4.0A$	$R_{DS(on)}$	--	52	65	$m\Omega$
<b>Drain-Source On-Resistance</b>	$V_{GS}=6V, I_D=2.0A$	$R_{DS(on)}$	--	60	85	$m\Omega$
<b>Zero Gate Voltage Drain Current</b>	$V_{DS}=150V, V_{GS}=0V$	$I_{DSS}$	--	--	1.0	$\mu A$
<b>Gate-Source Leakage Current</b>	$V_{DS}=0V, V_{GS}=\pm 25V$	$I_{GSS}$	--	--	$\pm 100$	$\mu A$
Dynamic Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
<b>Input Capacitance</b>	$V_{DS}=30V, V_{GS}=0V, F=1.0MHz$	$C_{iss}$	--	1764	--	pF
<b>Output Capacitance</b>		$C_{oss}$	--	148	--	
<b>Reverse Transfer Capacitance</b>		$C_{rss}$	--	62	--	
Switching Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
<b>Total Gate Charge</b>	$V_{DS}=75V, V_{GS}=10V, I_D=4.0A$	$Q_g$	--	29.5	--	nC
<b>Gate-Source Charge</b>		$Q_{gs}$	--	9.2	--	
<b>Gate-Drain Charge</b>		$Q_{gd}$	--	8.0	--	
<b>Turn-On Delay Time</b>	$V_{DD}=30V, V_{GS}=10V, R_G=6\Omega, I_D=1.0A$	$T_{d(on)}$	--	14	--	ns
<b>Turn-On Rise Time</b>		$T_r$	--	21	--	
<b>Turn-Off Delay Time</b>		$T_{d(off)}$	--	32	--	
<b>Turn-Off Fall Time</b>		$T_f$	--	23	--	
Drain-Source Body Diode	Conditions	Symbol	Min	Typ.	Max	Unit
<b>Drain-Source Diode Forward Current</b>	--	$I_s$	--	--	4.0	A
<b>Drain-Source Diode Forward Voltage</b>	$V_{GS}=0V, I_s=1.0A$	$V_{SD}$	--	0.7	1.0	V

Note:

1. Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics
3. The maximum current rating is package limited.
4. Repetitive rating, pulse width limited by junction temperature  $T_J(MAX)=150^{\circ}C$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J = 25^{\circ}C$ .
5. The test condition is  $L=0.1mH, I_{AS}=13A, V_{DD}=50V, V_{GS}=10V$
6.  $R_{eJA}$  is the sum of the junction to case to ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1inch FR-4 with 2oz. square pad of copper.
7. Guaranteed by design, not subject to production testing.



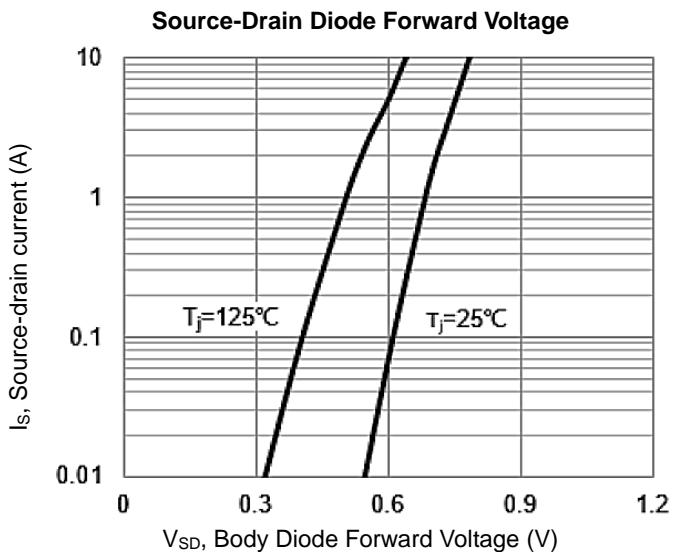
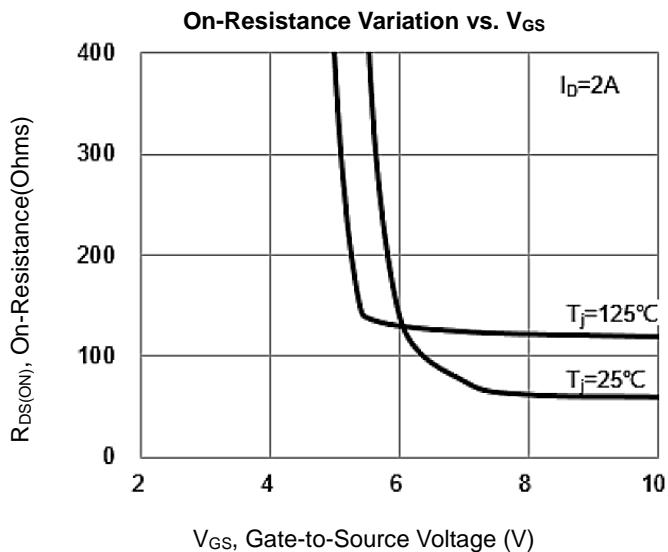
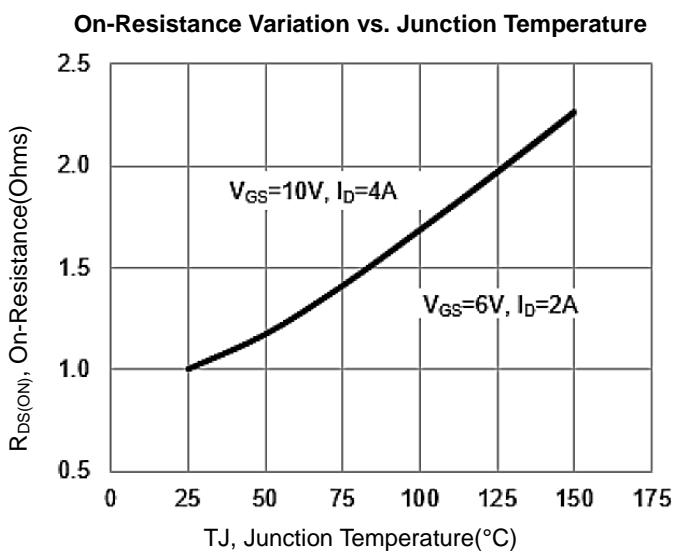
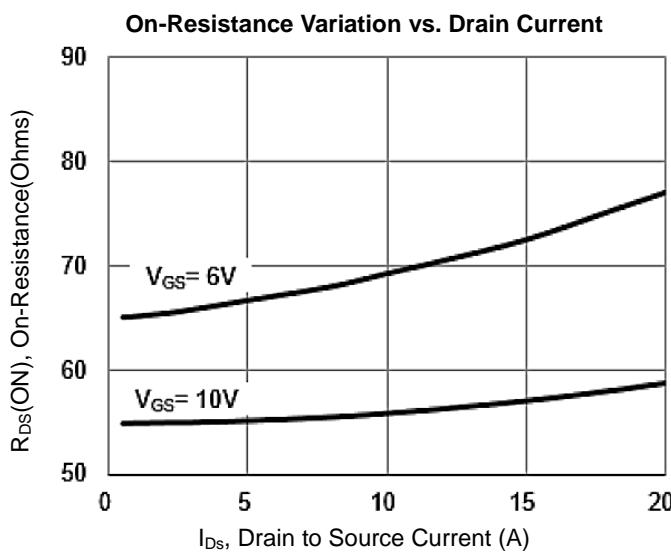
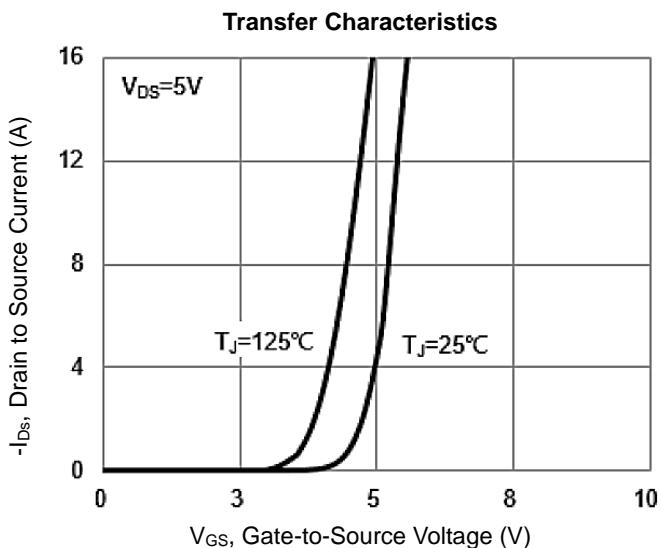
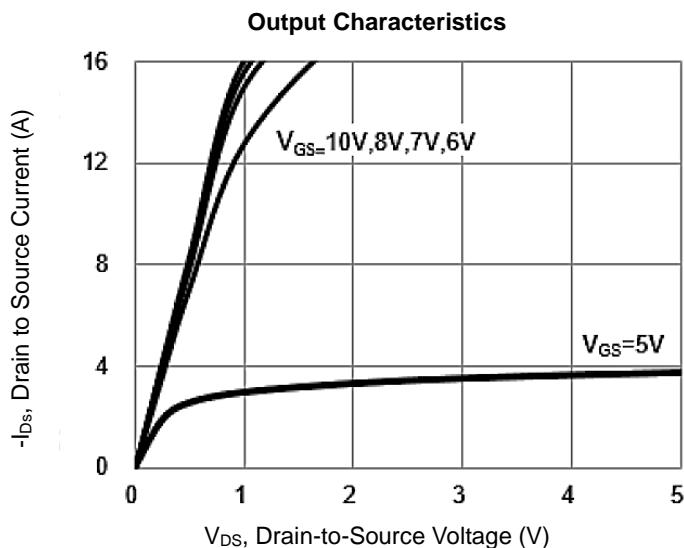
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### CHARACTERISTIC CURVES



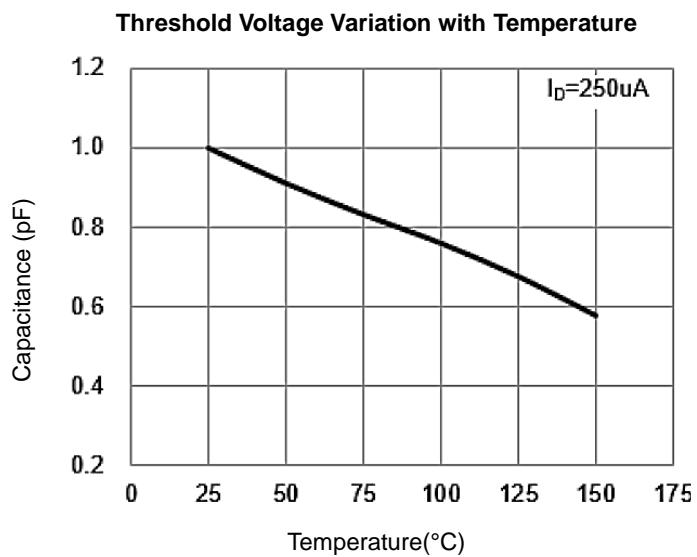
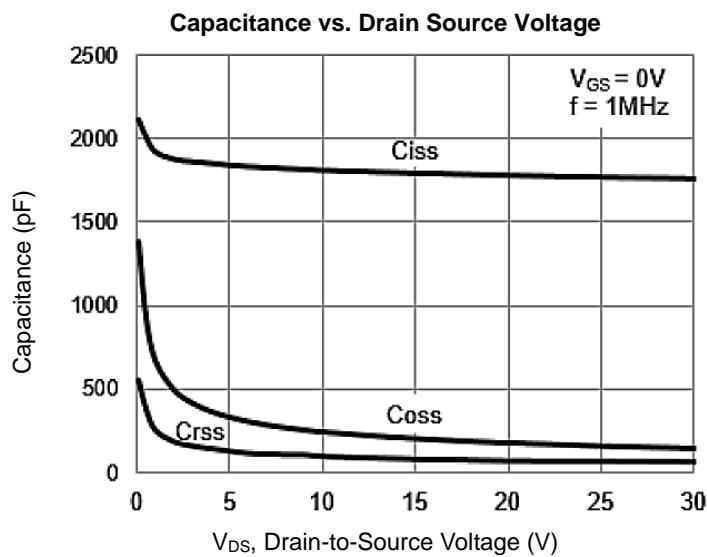
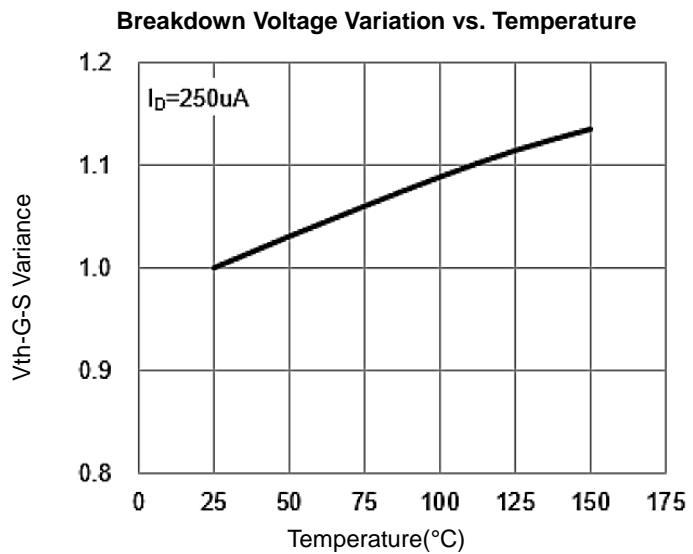
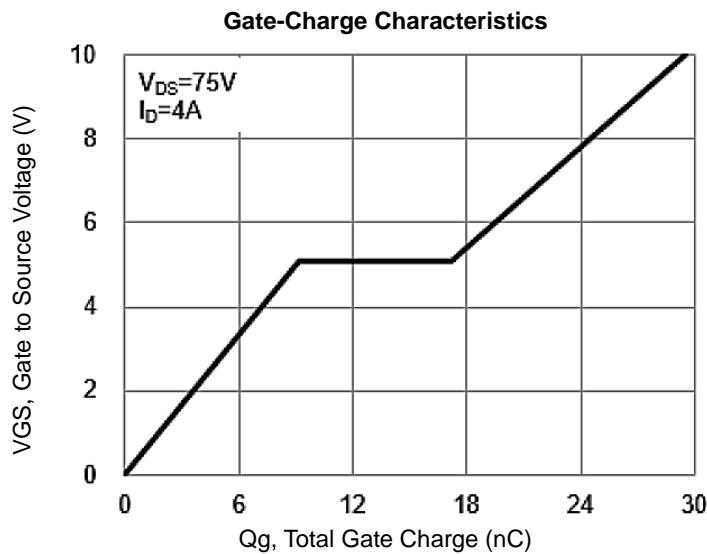
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### CHARACTERISTICS CURVES (CONTINUED)



\*Specifications subject to change without notice.